

FEATURES

- 34 dB Gain
- Very Low Distortion
- Stable with High VSWR Load Conditions
- Monolithic Design for Consistent Performance Part-to-Part
- Low DC Power Consumption
- Surface Mount Package Compatible with Automatic Assembly
- Low Cost Alternative to Hybrids
- RoHS Compliant Package Option

APPLICATIONS

- Line Extenders, Apartment House Amplifiers, System Amplifiers, Distribution Nodes



PRODUCT DESCRIPTION

The ACA2408 is a highly linear, monolithic GaAs RF amplifier that has been developed to replace, in new designs, standard CATV hybrid amplifiers. Offered in a convenient surface mount package, the MMIC consists of two pairs of parallel amplifiers that are optimized for exceptionally low distortion and noise

figure. A hybrid equivalent that provides flat gain response and excellent input and output return loss over the 40 to 870 MHz CATV downstream band is formed when one ACA2408 is cascaded between two appropriate transmission line baluns.

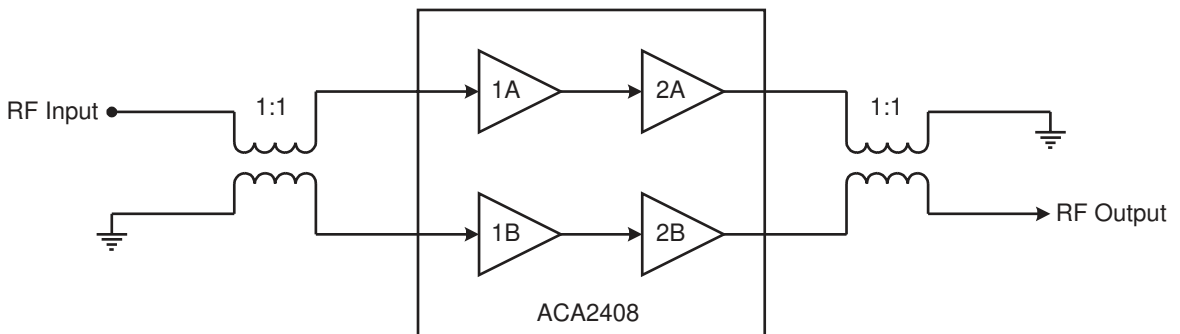


Figure 1: Hybrid Application Diagram

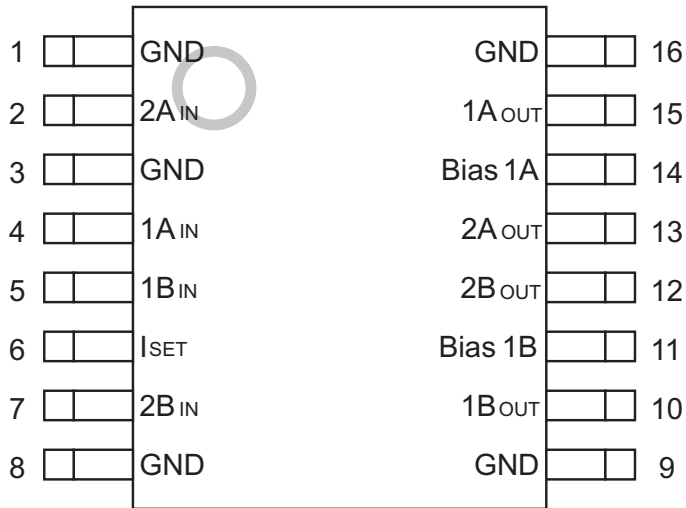


Figure 2: Pin Out

Table 1: Pin Description

| PIN | NAME | DESCRIPTION | PIN | NAME | DESCRIPTION |
|-----|------------------|--------------------|-----|-------------------|--------------------------------|
| 1 | GND | Ground | 16 | GND | Ground |
| 2 | 2A _{IN} | Amplifier 2A Input | 15 | 1A _{OUT} | Amplifier 1A Output |
| 3 | GND | Ground | 14 | Bias 1A | Bias for 1A Amplifier |
| 4 | 1A _{IN} | Amplifier 1A Input | 13 | 2A _{OUT} | Amplifier 2A Output and Supply |
| 5 | 1B _{IN} | Amplifier 1B Input | 12 | 2B _{OUT} | Amplifier 2B Output and Supply |
| 6 | I _{SET} | Current Adjust | 11 | Bias 1B | Bias for 1B Amplifier |
| 7 | 2B _{IN} | Amplifier 2B Input | 10 | 1B _{OUT} | Amplifier 1B Output |
| 8 | GND | Ground | 9 | GND | Ground |

ELECTRICAL CHARACTERISTICS

Table 2: Absolute Mimimum and Maximum Ratings

| PARAMETER | MIN | MAX | UNIT |
|--------------------------------|-----|------|------|
| Supply (pins 12, 13) | 0 | +28 | VDC |
| RF Power at Inputs (pins 4, 5) | - | +55 | dBmV |
| Storage Temperature | -65 | +150 | °C |
| Soldering Temperature | - | +260 | °C |
| Soldering Time | - | 5.0 | Sec |

Stresses in excess of the absolute ratings may cause permanent damage. Functional operation is not implied under these conditions. Exposure to absolute ratings for extended periods of time may adversely affect reliability.

Notes:

1. Pins 2, 4, 5 and 7 should be AC-coupled. No external DC bias should be applied.
2. Pin 6 should be AC-grounded and/or pulled to ground through a resistor for current control.
3. Pins 11 and 14 are bias feeds for input amplifiers 1A and 1B. No external DC bias should be applied.
4. Pins 10 and 15 receive DC bias directly from pins 11 and 14.

Table 3: Operating Ranges

| PARAMETER | MIN | TYP | MAX | UNIT |
|---------------------------------------|-----|-----|------|------|
| Supply: V _{DD} (pins 12, 13) | - | +24 | - | VDC |
| Voltage at I _{SET} (pin 6) | - | +3 | - | VDC |
| RF Frequency | 40 | - | 870 | MHz |
| Case Temperature | -40 | - | +110 | °C |

The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

Table 4: AC and DC Electrical Specifications
(T_A = +25 °C, V_{DD} = +24 VDC)

| PARAMETER | MIN | TYP | MAX | UNIT | COMMENTS |
|--|------|---------------------------------|-------------------------------|------|---|
| Gain ⁽¹⁾ @ 870 MHz | 33.5 | 34.8 | - | dB | |
| Cable Equivalent Slope ⁽¹⁾ | - | 0 | - | dB | |
| Gain Flatness ⁽¹⁾ to 870 MHz | - | ±0.2 | - | dB | |
| Noise Figure ⁽¹⁾ | - | 2.0 | 4.0 | dB | |
| CTB ⁽¹⁾ 110 Channels ⁽²⁾ | - | -70 | -58 | dBc | |
| CSO ⁽¹⁾ 110 Channels ⁽²⁾ | - | -68 | -58 | dBc | |
| XMOD ⁽¹⁾ 110 Channels ⁽²⁾ | - | -65 | -55 | dBc | |
| Input Return Loss ⁽¹⁾ (75 Ω System) | - | -25 -28 -26 -20 -21 | -20 - - -15.5 -14 | dB | 40 to 80 MHz 80 to 160 MHz 160 to 320 MHz 320 to 640 MHz 640 to 870 MHz |
| Output Return Loss ⁽¹⁾ (75 Ω System) | - | -27 -24 -20 -17 -17 | -20 - - -15.5 -14 | dB | 40 to 80 MHz 80 to 160 MHz 160 to 320 MHz 320 to 640 MHz 640 to 870 MHz |
| Supply Current | - | 325 | 340 | mA | |
| Thermal Resistance | - | - | 4.5 | °C/W | |

Notes:

(1) Measured with baluns on the input and output of the device.

(2) Flat output, +44 dBmV per channel.

PERFORMANCE DATA

Figure 3: Gain (S21) vs. Frequency
 (TA = +25 °C, VDD = +24 V, 75 Ω system)

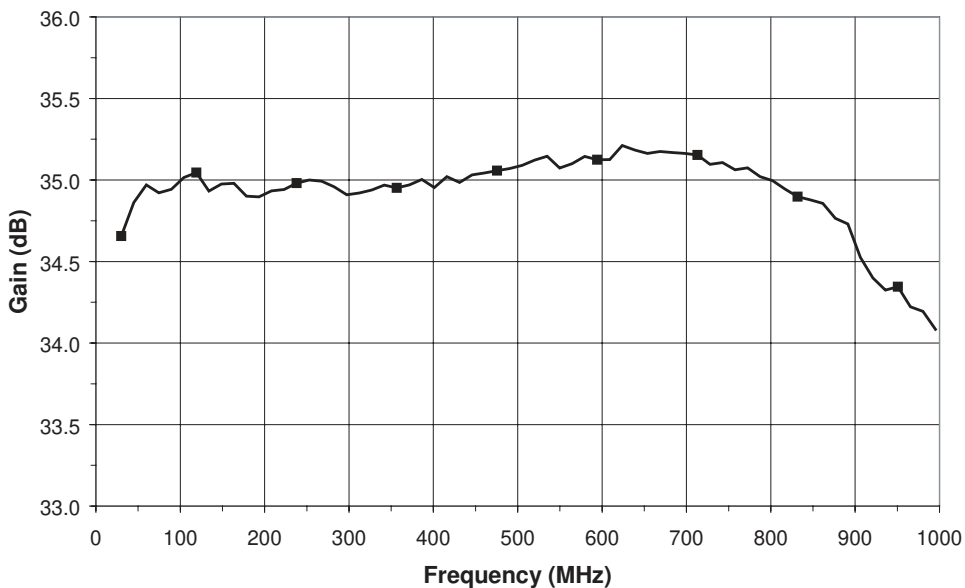


Figure 4: Input and Output Return Loss (S11 and S22) vs. Frequency
 (TA = +25 °C, VDD = +24 V, 75 Ω system)

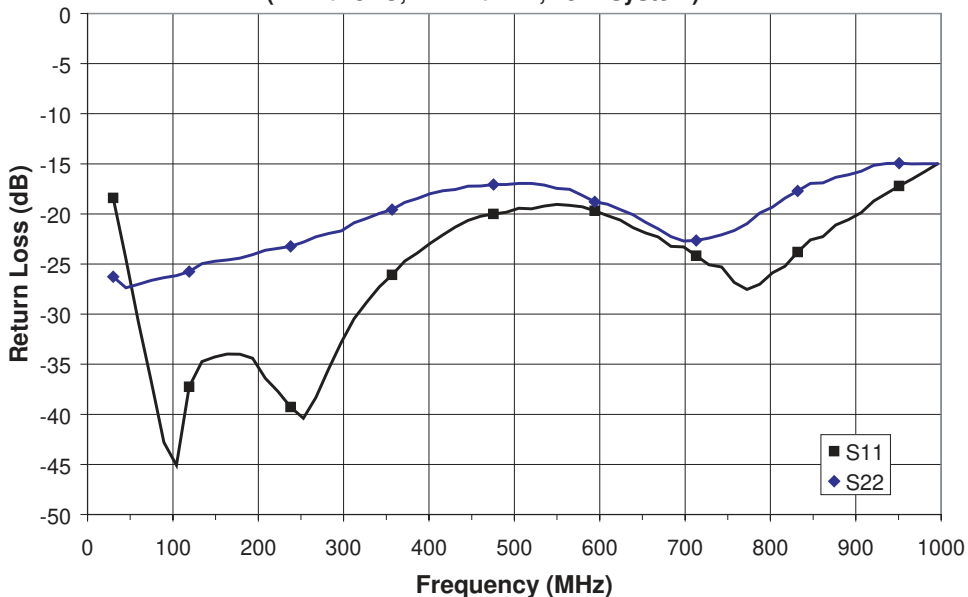


Figure 5: Isolation (S12) vs. Frequency
 (T_A = +25 °C, V_{DD} = +24 V, 75 Ω system)

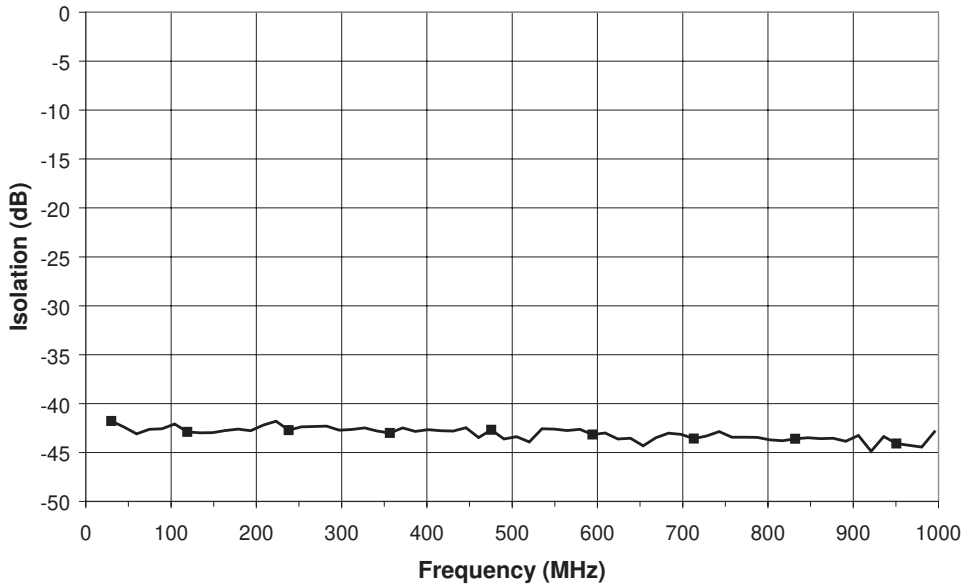


Figure 6: Noise Figure vs. Frequency
 (T_A = +25 °C, V_{DD} = +24 V)

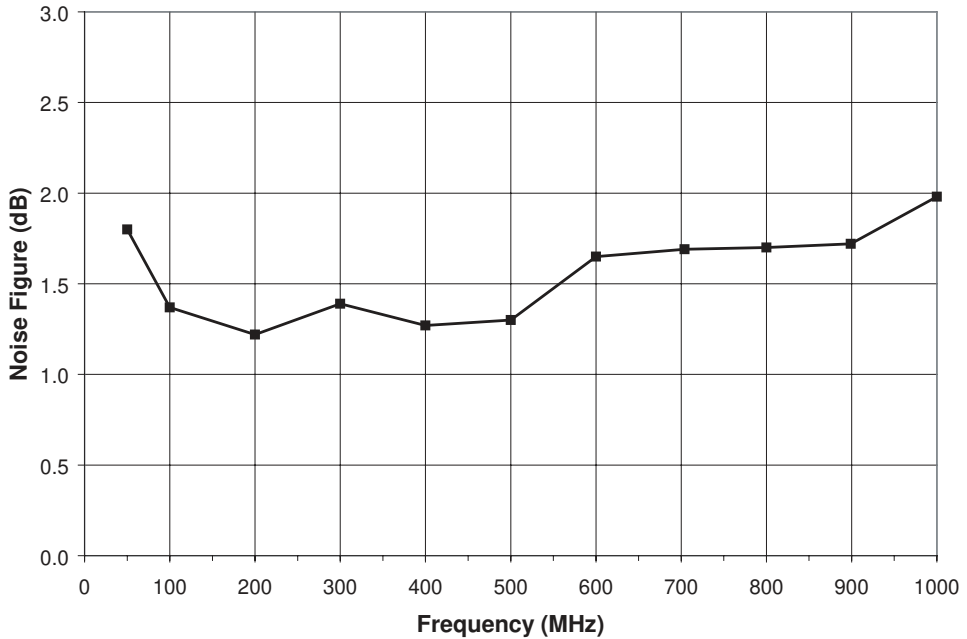


Figure 7: CTB vs. Frequency
 (110 channels, +44 dBmV output power, flat output)

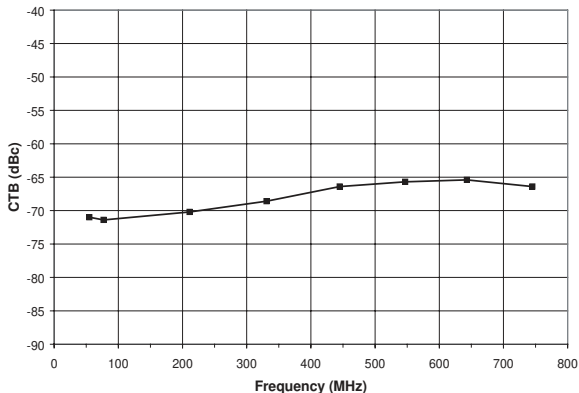


Figure 8: CSO vs. Frequency
 (110 channels, +44 dBmV output power, flat output)

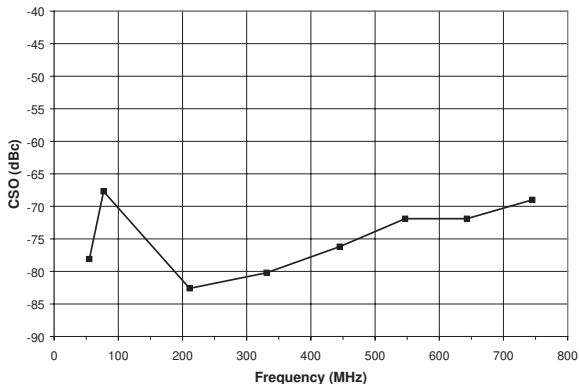


Figure 9: XMOD vs. Frequency
 (110 channels, +44 dBmV output power, flat output)

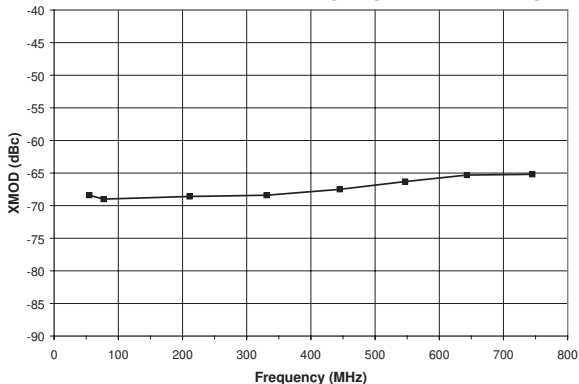


Figure 10: CTB vs. Frequency
 (132 channels, +44 dBmV output power, flat output)

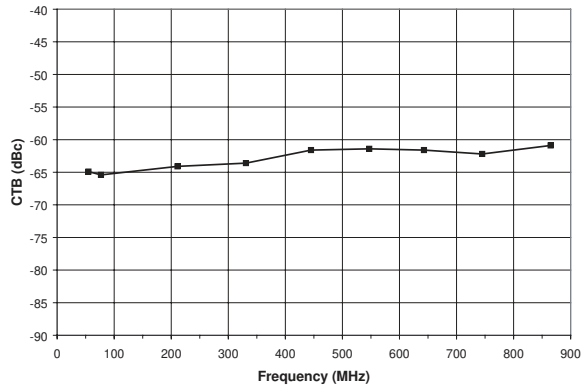


Figure 11: CSO vs. Frequency
 (132 channels, +44 dBmV output power, flat output)

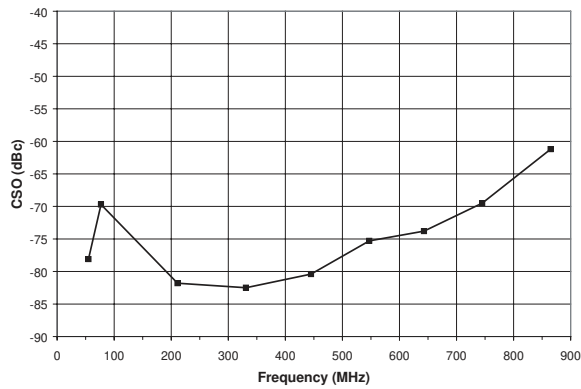
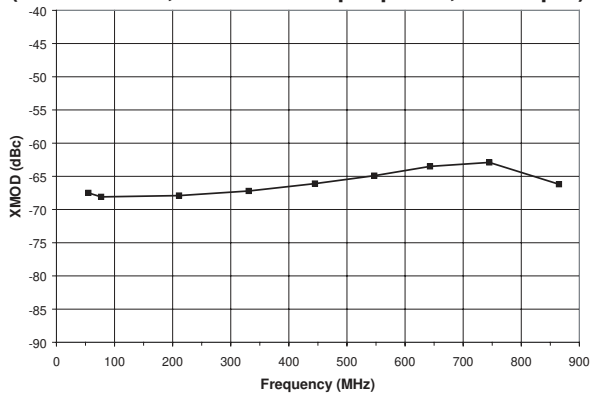


Figure 12: XMOD vs. Frequency
 (132 channels, +44 dBmV output power, flat output)



APPLICATION INFORMATION

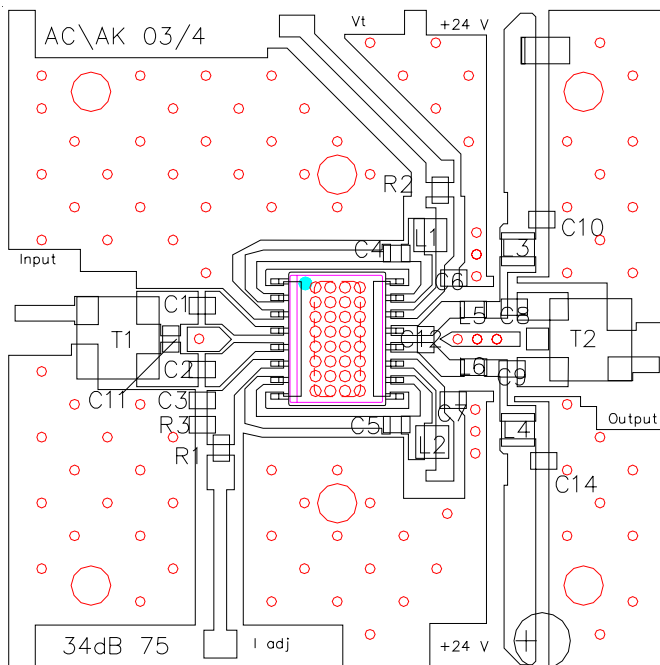


Figure 13: Evaluation Board Layout

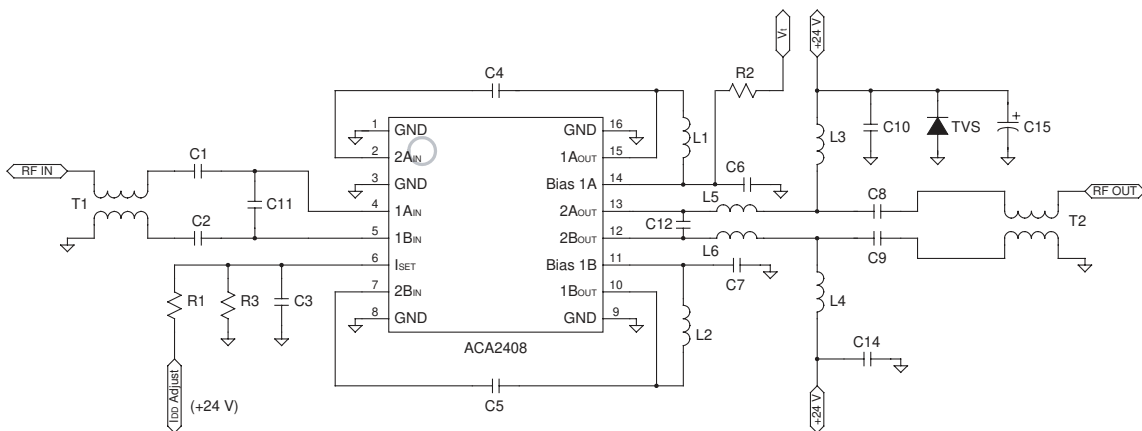


Figure 14: Evaluation Board Schematic

Table 5: Evaluation Board Parts List

| REF | DESCRIPTION | QTY | VENDOR | VENDOR P/N |
|----------------------------------|--------------------------------------|-----|-----------------------------|-----------------|
| C1, C2, C3, C6, C7, C10, C14 | 0.01 μ F CHIP CAP | 7 | MURATA | GRM39X7R103K50V |
| C4, C5, C8, C9 | 470 pF CHIP CAP | 4 | MURATA | GRM39X7R471K50V |
| C11, C12 | 0.5 pF CHIP CAP | 2 | MURATA | GRM36COG0R5C50 |
| C15 | 47 μ F ELECT CAP | 1 | DIGI-KEY CORP | P5275-ND |
| L1, L2, L3, L4 ⁽⁴⁾ | 680 nH INDUCTOR | 4 | COIL CRAFT | 1008CS-681XKBC |
| L5, L6 ⁽⁴⁾ | 1.5 nH CHIP INDUCTOR | 2 | TOKO | PTL2012-F1N5C |
| R3 | 13 k Ω Resistor | 1 | DIGI-KEY CORP | P13KGCT-ND |
| R1, R2 | NOT USED | | | |
| TVS | TVS 24 VOLT 600 WATT | 1 | DIGI-KEY CORP | SMBJ24ACCCT-ND |
| CONNECTOR ⁽¹⁾ | 75 Ω MALE PANEL MOUNT | 2 | PASTERNAK ENTERPRISES | PE4504 |
| T1, T2 ⁽²⁾ (BALUN) | Ferrite Core | 2 | FAIR-RITE | 2843002702 |
| | Wire | | MWS WIRE IND. | T-2361429-20 |
| | Printed Circuit Board ⁽³⁾ | 1 | STANDARD PRINTED CIRC. INC. | 24V2X1AC75 |
| INDIUM | 300 X 160 MILS | 1 | INDIUM CORP OF AMERICA | 14996Y |

Notes:

- (1) N connector center pin should be approximately 80 mils in length.
- (2) T1, T2, balun: 4.5 turns thru, as shown in Figure 15.
- (3) Due to the power dissipation of this device, the printed circuit board should be mounted / attached to a heat sink.
- (4) 400 mA minimum current rating.

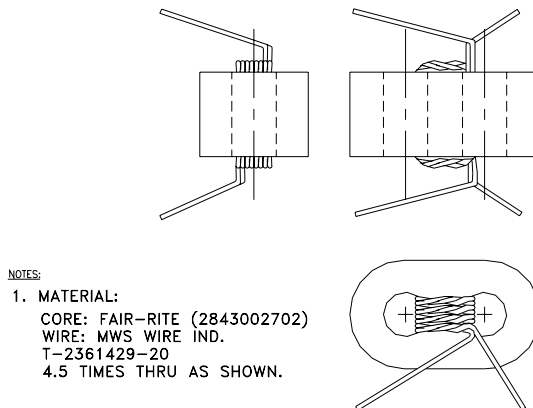
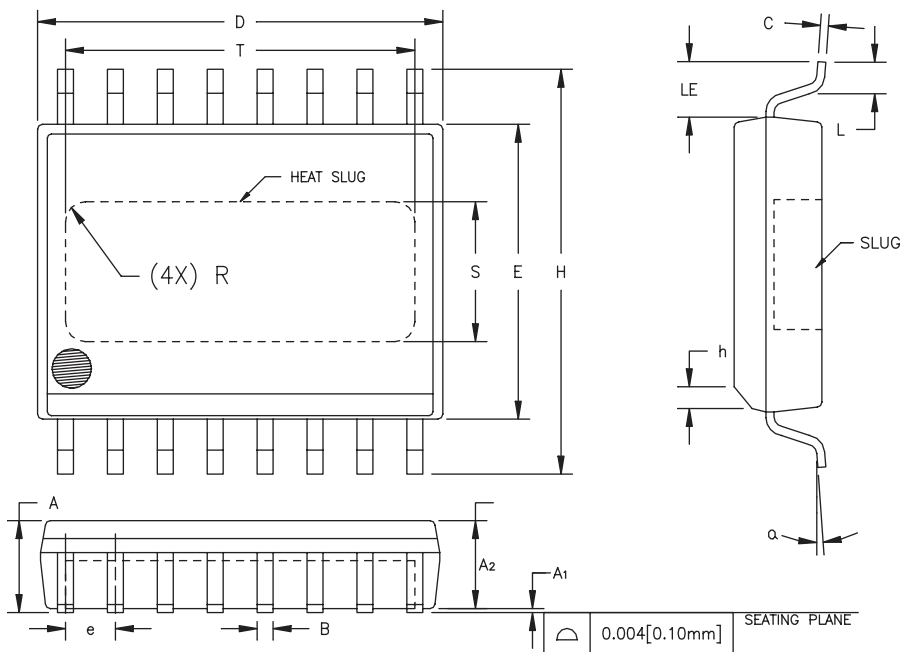


Figure 15: Balun Drawing

PACKAGE OUTLINE



| S _M , B _{OL} | INCHES | | MILLIMETERS | | NOTE |
|----------------------------------|------------|-------|-------------|-------|------|
| | MIN. | MAX. | MIN. | MAX. | |
| A | 0.087 | 0.098 | 2.21 | 2.49 | |
| A ₁ | 0.000 | 0.004 | 0.00 | 0.10 | 6 |
| A ₂ | 0.087 | 0.094 | 2.21 | 2.39 | |
| B | 0.013 | 0.019 | 0.33 | 0.48 | |
| C | 0.007 | 0.009 | 0.18 | 0.23 | |
| D | 0.398 | 0.412 | 10.11 | 10.46 | 2 |
| E | 0.290 | 0.300 | 7.37 | 7.62 | 3 |
| e | 0.050 BSC | | 1.27 BSC | | 4 |
| H | 0.394 | 0.418 | 10.01 | 10.62 | |
| h | 0.010 | 0.028 | 0.25 | 0.71 | |
| L | 0.024 | 0.040 | 0.61 | 1.02 | |
| LE | 0.052 | — | 1.32 | — | |
| α | 0° | 8° | 0° | 8° | |
| S | 0.120 | 0.140 | 3.05 | 3.56 | 5 |
| T | 0.330 | 0.350 | 8.38 | 8.89 | 5 |
| R | REF. 0.015 | | REF. 0.38 | | 5 |

NOTES:

1. CONTROLLING DIMENSION: INCHES
2. DIMENSION "D" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED 0.006 [0.15mm] PER SIDE.
3. DIMENSION "E" DOES NOT INCLUDE INTER-LEAD FLASH OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT EXCEED 0.010 [0.25mm] PER SIDE.
4. MAXIMUM LEAD TWIST/SKEW TO BE ±0.005 [0.13mm].
5. DIMENSIONS "S", "T" AND "R" INDICATE EXPOSED SLUG AREA.
6. STANDOFF HEIGHT (A₁) MEASURED FROM BOTTOM OF SLUG.

Figure 16: S7 Package Outline - 16 Pin Wide Body SOIC with Heat Slug

ORDERING INFORMATION

| ORDER NUMBER | TEMPERATURE RANGE | PACKAGE DESCRIPTION | COMPONENT PACKAGING |
|---------------------|--------------------------|--|-------------------------------------|
| ACA2408S7P2 | -40 °C to +110 °C | 16 Pin Wide Body SOIC with Heat Slug | Tape and Reel, 1500 pieces per Reel |
| ACA2408S7P0 | -40 °C to +110 °C | 16 Pin Wide Body SOIC with Heat Slug | Plastic Tubes, 50 pieces per Tube |
| ACA2408RS7P2 | -40 °C to +110 °C | RoHS Compliant 16 Pin Wide Body SOIC with Heat Slug | Tape and Reel, 1500 pieces per Reel |
| ACA2408RS7P0 | -40 °C to +110 °C | RoHS Compliant 16 Pin Wide Body SOIC with Heat Slug | Plastic Tubes, 50 pieces per Tube |

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